

09-06-2002



102213978
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New *8/22/02*

Resubmission (Non-Recordation)
Document ID#

Correction of PTO Error
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Conveyance Type

Assignment Security Agreement

License Change of Name

Merger Other

U.S. Government
(For Use ONLY by U.S. Government Agencies)

Departmental File Secret File

Conveying Party(ies)

Mark if additional names of conveying parties attached

Execution Date
Month Day Year

Name (line 1) ILLINOIS INSTITUTE OF TECHNOLOGY

07/25/2002

Name (line 2) an Illinois corporation

Second Party

Execution Date
Month Day Year

Name (line 1)

Name (line 2)

Receiving Party

Mark if additional names of receiving parties attached

Name (line 1) University of Chicago, The

If document to be recorded is an assignment and the receiving party is not domiciled in the United States, an appointment of a domestic representative is attached. (Designation must be a separate document from Assignment.)

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Address (line 3) Chicago Illinois 60635

City

State/Country

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Mail documents to be recorded with required cover sheet(s) information to:
Commissioner of Patents and Trademarks, Box Assignments, Washington, D.C. 20231

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Pages Enter the total number of pages of the attached conveyance document including any attachments. #

Application Number(s) or Patent Number(s) Mark if additional numbers attached

Enter either the Patent Application Number or the Patent Number (DO NOT ENTER BOTH numbers for the same property).

Patent Application Number(s)

Patent Number(s)

If this document is being filed together with a new Patent Application, enter the date the patent application was signed by the first named executing inventor.

Month	Day	Year
<input type="text"/>	<input type="text"/>	<input type="text"/>

Patent Cooperation Treaty (PCT)

Enter PCT application number only if a U.S. Application Number has not been assigned.

PCT

PCT

PCT

PCT

PCT

PCT

Number of Properties Enter the total number of properties involved. #

Fee Amount Fee Amount for Properties Listed (37 CFR 3.41): \$

Method of Payment: Enclosed Deposit Account

Deposit Account (Enter for payment by deposit account or if additional fees can be charged to the account.)

Deposit Account Number: #

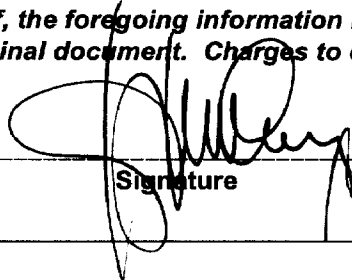
Authorization to charge additional fees: Yes No

Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Charges to deposit account are authorized, as indicated herein.

Harry M. Levy

Name of Person Signing



Signature

8/27/02

Date

ASSIGNMENT

WHEREAS, The Illinois Institute of Technology (herein called IIT) has the right to acquire and did acquire rights in an invention entitled "Metallic Substrates for High Temperature Superconductors" described in U.S. Patent Application No. 09/568,890 filed May 11, 2000, naming as inventors Thomas G. Truchan, Dean J. Miller, Kenneth C. Goretta, Uthamalingam Balachandran, and Robert P. Foley.

WHEREAS, by document attached hereto as Appendix A, and hereby incorporated by reference, Robert P. Foley (herein called the INVENTOR) has assigned and transferred his entire right, title and interest in the INVENTION to IIT.

WHEREAS, the INVENTION is a Subject Invention under Prime Contract W-31-109-ENG-38 between the University of Chicago, as Operator of Argonne National Laboratory (herein called the UNIVERSITY), and the U.S. Department of Energy, and the UNIVERSITY has requested that the IIT assign its rights and title in the INVENTION to the UNIVERSITY.

NOW THEREFORE, IIT hereby assigns and transfers to the UNIVERSITY all its right title and interest throughout the world in the INVENTION and to any and all Letters Patent where ever they may be granted thereon as well as reissues and extensions of said Letters Patent; the same to be held to the full end of the term or terms for which said Letters Patent are or may be granted, reissued, or extended, as fully and entirely as the same would be held by IIT had this assignment not been made.

IIT agrees to make, execute, and deliver or have the INVENTOR make, execute and deliver unto the UNIVERSITY any and all papers, documents, affidavits, renewals, divisions and reissue applications, statements and other instruments in such usual and other forms, terms, and contents as may be required or incident to the prosecution or conduct of any and all applications, before as well as after the issuance of any Letters Patent thereon, or in the adjustment or settlement of any interferences or other actions or proceedings that said application may encounter or in which they may become involved.

As consideration for the above assignment and assistance, the UNIVERSITY hereby agrees that the INVENTOR will share in any distribution of royalties arising from any patent application claiming the INVENTION and naming the INVENTOR as an inventor, such share to be equal to the share of each of the inventors named in such patent application that are employed by the UNIVERSITY.

The Illinois Institute of Technology

By Robert D. Anderson
Title DIRECTOR TECH TRANSFER
Date 6/26/02
Witness: Judith Healy

The University of Chicago
As Operator of Argonne National Laboratory

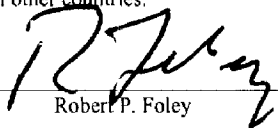
By [Signature]
Title ASST. V.P. FOR STRATEGIC DEV.
Date 8/8/02
Witness: Mary Ann Healy

Acknowledged:
[Signature]
Robert P. Foley
Date 7.25.02

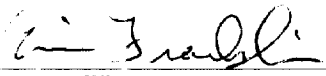
ASSIGNMENT

I, Robert P. Foley of Hinsdale, in the State of Illinois, for good and valuable consideration to me in hand paid, the receipt and sufficiency whereof is hereby acknowledged, have sold, assigned, conveyed and set over, and do hereby sell, assign, convey and set over unto the ILLINOIS INSTITUTE OF TECHNOLOGY, an Illinois corporation, organized under the laws of the State of Illinois, having a place of business at 3301 South Dearborn Street, Chicago, Illinois, its successors and assigns, the entire right, title and interest in and to all subject matter invented or designed by me and disclosed in the patent application for the METALLIC SUBSTRATES FOR HIGH TEMPERATURE SUPERCONDUCTORS filed in the U.S. Patent & Trademark Office on May 11, 2000, and assigned serial No. 09/568,890, and any divisions and continuations thereof and in and to all Letters Patent of the United States, including any reissues and extensions thereof that may be obtained therefor, and the right, where such right can be legally exercised, in its own name to apply for and obtain Letters Patent, Inventor's Certificates, Utility Models and Designs, in countries foreign to the United States, including the full right to claim for any such application the benefits of the International Convention as fully and entirely as I could have done if the application had been in my name, and the entire interest in any Letters Patent, Inventor's Certificate, Utility Model or Design which may be granted on any such application in such foreign country; and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States, and any official of any country or countries foreign to the United States whose duty it is to issue Letters Patent, Inventor's Certificates, Utility Models or Designs, on applications as aforesaid, to issue any and all Letters Patent, Inventor's Certificates, Utility Models and Designs that may be granted for said invention to said ILLINOIS INSTITUTE OF TECHNOLOGY, its successors and assigns.

And for the above-named considerations, I hereby agree that I will without additional compensation but without cost to myself, promptly communicate to said ILLINOIS INSTITUTE OF TECHNOLOGY, its successors and assigns, any facts known to me respecting said invention whenever requested, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications for Letters Patent, Inventor's Certificates, Utility Models and Designs and assignments thereof, make all rightful oaths and generally do everything possible to aid said assignee, its successors and assigns, as and when requested by them, in obtaining and enforcing proper Letters Patents, Inventor's Certificate, Utility Model and Design protection for said invention or inventions and improvements, in the United States and in all other countries.



Robert P. Foley



Witness

7-25-02

Date

7/25/02

Date

Correspondent Name and Address

Area Code and Telephone Number

Name

Address (line 1)

Address (line 2)

Address (line 3)

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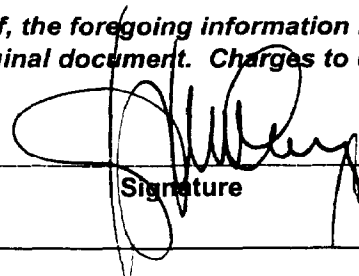
Authorization to charge additional fees: Yes No

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Harry M. Levy

Name of Person Signing



Signature

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